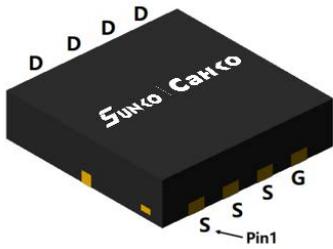
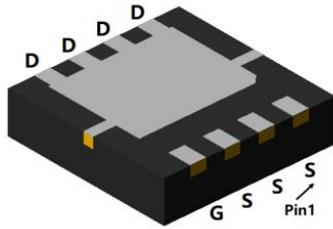


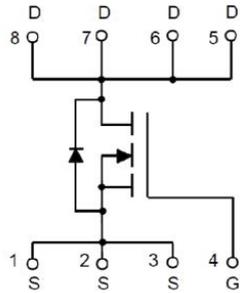
N-Channel Enhancement Mode Field Effect Transistor



Top View



Bottom View



DFN3333-8L

Product Summary

- $V_{DS}$  30V
- $I_D$  30A
- $R_{DS(ON)}$  (at  $V_{GS}=10V$ ) <9 mohm
- $R_{DS(ON)}$  (at  $V_{GS}=4.5V$ ) <13 mohm
- 100% EAS Tested

General Description

- Trench Power LV MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$
- Moisture Sensitivity Level 3
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- High current load applications
- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

Absolute Maximum Ratings ( $T_A=25^{\circ}C$  unless otherwise noted)

| Parameter   |                    | Symbol          | Limit    | Unit          |
|---|--------------------|-----------------|----------|---------------|
| Drain-source Voltage                                |                    | $V_{DS}$        | 30       | V             |
| Gate-source Voltage                                 |                    | $V_{GS}$        | $\pm 20$ | V             |
| Drain Current                                       | $T_A=25^{\circ}C$  | $I_D$           | 14       | A             |
|   | $T_A=100^{\circ}C$ |                 | 9        |               |
|   | $T_C=25^{\circ}C$  |                 | 30       |               |
|   | $T_C=100^{\circ}C$ |                 | 19       |               |
| Pulsed Drain Current <sup>A</sup>                   |                    | $I_{DM}$        | 115      | A             |
| Total Power Dissipation                             | $T_A=25^{\circ}C$  | $P_D$           | 2.5      | W             |
|   | $T_A=100^{\circ}C$ |                 | 1        |               |
|   | $T_C=25^{\circ}C$  |                 | 17       |               |
|   | $T_C=100^{\circ}C$ |                 | 7        |               |
| Single Pulse Avalanche Energy <sup>B</sup>          |                    | $E_{AS}$        | 60.5     | mJ            |
| Thermal Resistance Junction-to-Case <sup>C</sup>    |                    | $R_{\theta JC}$ | 7.1      | $^{\circ}C/W$ |
| Thermal Resistance Junction-to-Ambient <sup>C</sup> |                    | $R_{\theta JA}$ | 50       | $^{\circ}C/W$ |
| Junction and Storage Temperature Range              |                    | $T_J, T_{STG}$  | -55~+150 | $^{\circ}C$   |

Ordering Information (Example)

| PREFERRED P/N | PACKING CODE | Marking | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|--------------|---------|----------------------|-------------------------|----------------------------|---------------|
| SCQ30N03A     | F1           | Q30N03  | 5000                 | 10000                   | 100000                     | 13" reel      |

## ■ Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

| Parameter                             | Symbol               | Conditions  | Min                   | Typ  | Max  | Units |
|---------------------------------------|----------------------|---|-----------------------|------|------|-------|
| <b>Static Parameter</b>               |                      |   |                       |      |      |       |
| Drain-Source Breakdown Voltage        | BV <sub>DSS</sub>    | V <sub>GS</sub> = 0V, I <sub>D</sub> =250μA   | 30                    |      |      | V     |
| Zero Gate Voltage Drain Current       | I <sub>DSS</sub>     | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V   | T <sub>J</sub> =25°C  |      | 1    | μA    |
|                                       |                      |   | T <sub>J</sub> =150°C |      | 100  |       |
| Gate-Body Leakage Current             | I <sub>GSS</sub>     | V <sub>GS</sub> = ±20V, V <sub>DS</sub> =0V   |                       |      | ±100 | nA    |
| Gate Threshold Voltage                | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250μA                               | 1.0                   | 1.5  | 2.5  | V     |
| Static Drain-Source On-Resistance     | R <sub>DS(on)</sub>  | V <sub>GS</sub> = 10V, I <sub>D</sub> =15A  |                       | 5.8  | 9    | mΩ    |
|                                       |                      | V <sub>GS</sub> = 4.5V, I <sub>D</sub> =15A   |                       | 10   | 13   |       |
| Diode Forward Voltage                 | V <sub>SD</sub>      | I <sub>S</sub> =15A, V <sub>GS</sub> =0V  |                       | 0.85 | 1.2  | V     |
| Maximum Body-Diode Continuous Current | I <sub>S</sub>       |   |                       |      | 30   | A     |
| <b>Dynamic Parameters</b>             |                      |   |                       |      |      |       |
| Input Capacitance                     | C <sub>iss</sub>     | V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f=1MHZ                                       |                       | 1015 |      | pF    |
| Output Capacitance                    | C <sub>oss</sub>     |   |                       | 201  |      |       |
| Reverse Transfer Capacitance          | C <sub>rss</sub>     |   |                       | 164  |      |       |
| Gate Resistance                       | R <sub>g</sub>       | f= 1MHZ   |                       | 1.5  |      | Ω     |
| <b>Switching Parameters</b>           |                      |   |                       |      |      |       |
| Total Gate Charge                     | Q <sub>g</sub>       | V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, I <sub>D</sub> =20A                         |                       | 23.6 |      | nC    |
| Total Gate Charge                     | Q <sub>g(4.5V)</sub> |   |                       | 12.9 |      |       |
| Gate-Source Charge                    | Q <sub>gs</sub>      |   |                       | 3.9  |      |       |
| Gate-Drain Charge                     | Q <sub>gd</sub>      |   |                       | 7    |      |       |
| Reverse Recovery Charge               | Q <sub>rr</sub>      | I <sub>F</sub> =15A, di/dt=100A/us  |                       | 0.2  |      | ns    |
| Reverse Recovery Time                 | t <sub>rr</sub>      |   |                       | 5    |      |       |
| Turn-on Delay Time                    | t <sub>D(on)</sub>   | V <sub>GS</sub> =10V, V <sub>DD</sub> =20V, I <sub>D</sub> =2A,<br>R <sub>GEN</sub> =3Ω |                       | 7    |      | ns    |
| Turn-on Rise Time                     | t <sub>r</sub>       |   |                       | 19   |      |       |
| Turn-off Delay Time                   | t <sub>D(off)</sub>  |   |                       | 24   |      |       |
| Turn-off fall Time                    | t <sub>f</sub>       |   |                       | 24   |      |       |

A. Pulse Test: Pulse Width ≤ 300us, Duty cycle ≤ 2%.

B. T<sub>J</sub>=25°C, V<sub>DD</sub>=25V, V<sub>G</sub>=10V, L=1mH, I<sub>AS</sub>=11A

C. R<sub>θJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>θJC</sub> is guaranteed by design, while R<sub>θJA</sub> is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.

■ Typical Performance Characteristics

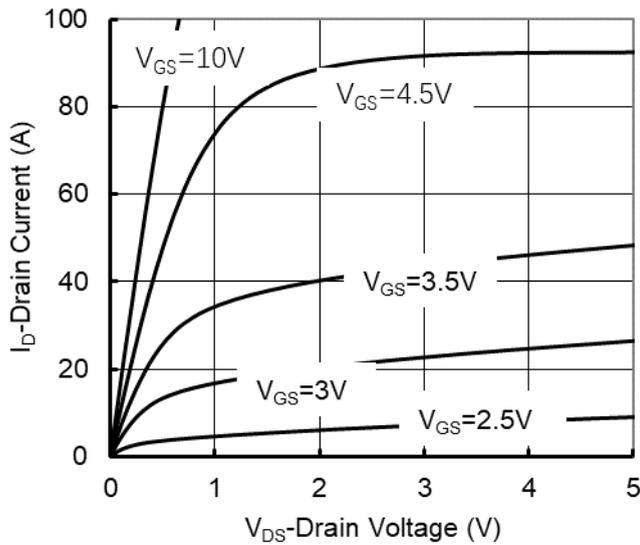


Figure1. Output Characteristics

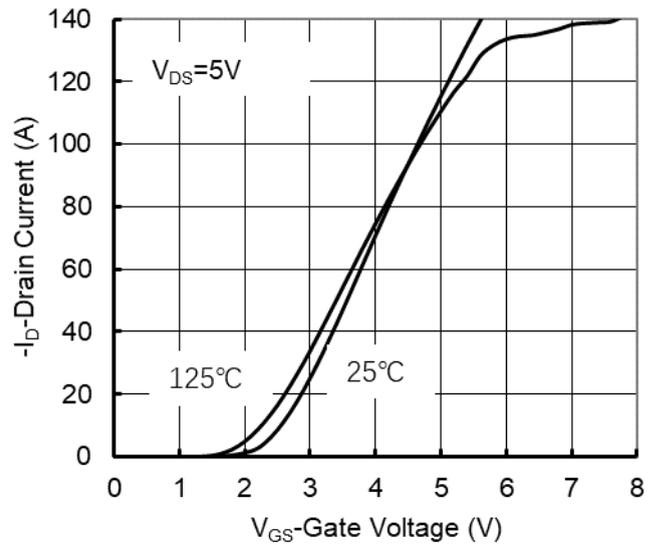


Figure2. Transfer Characteristics

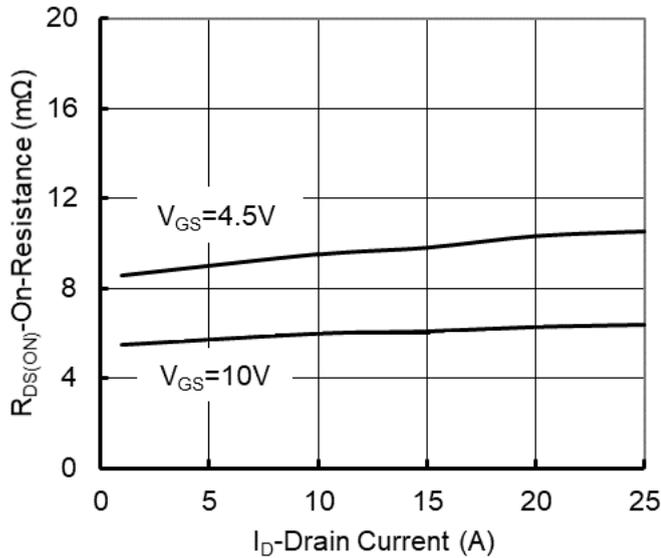


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

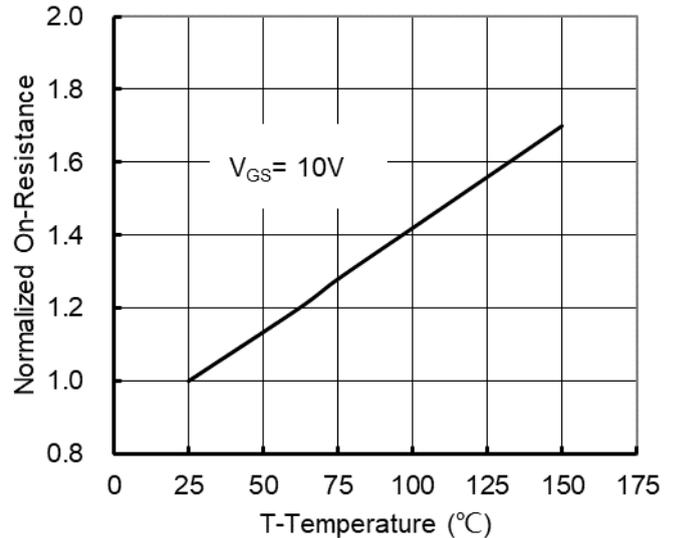


Figure 4: On-Resistance vs. Junction Temperature

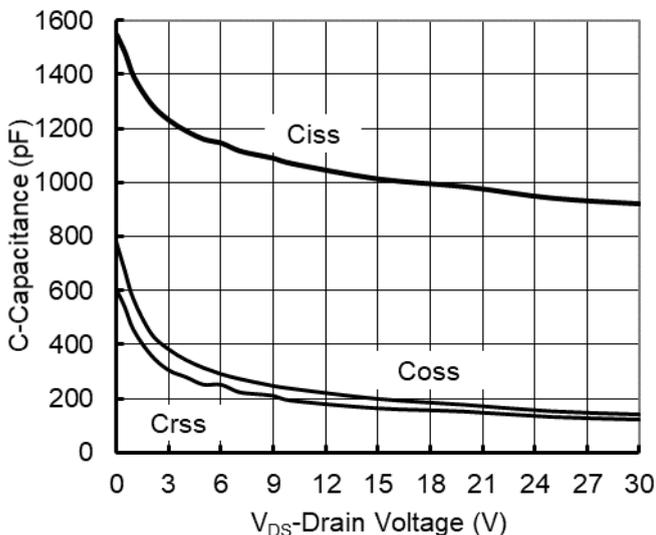


Figure5. Capacitance Characteristics

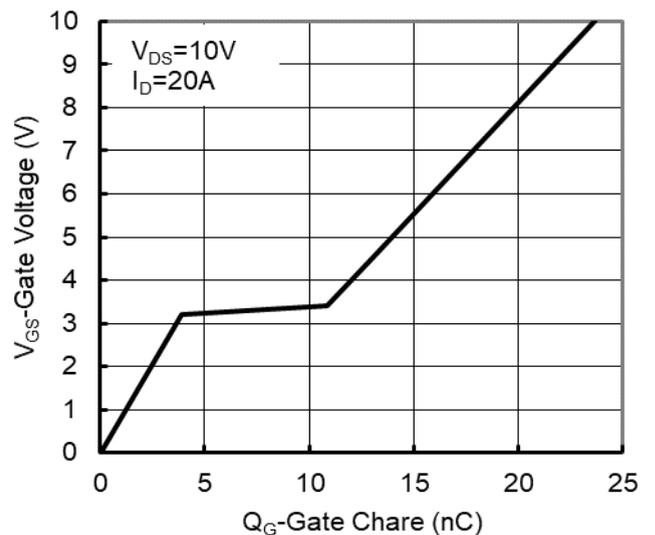


Figure6. Gate Charge

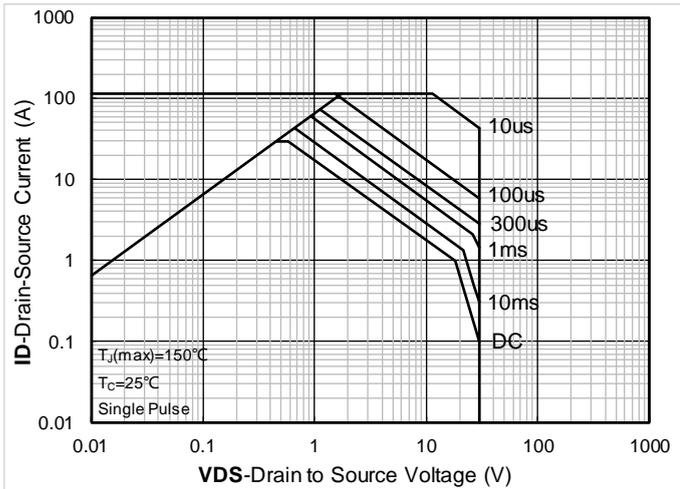


Figure7. Safe Operation Area

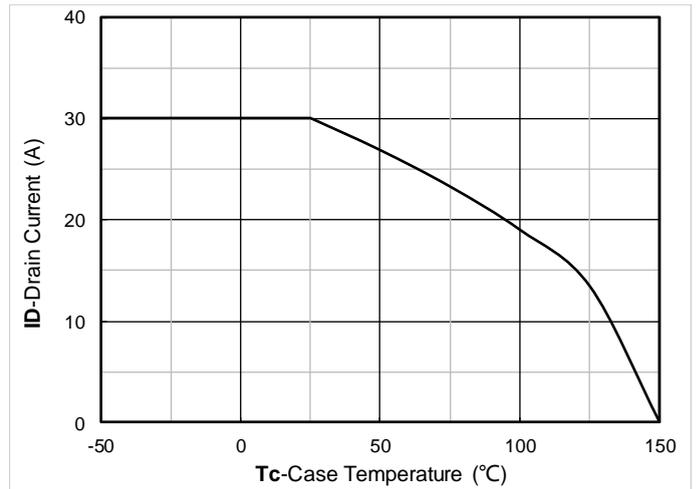


Figure8. Maximum Continuous Drain Current vs Case Temperature

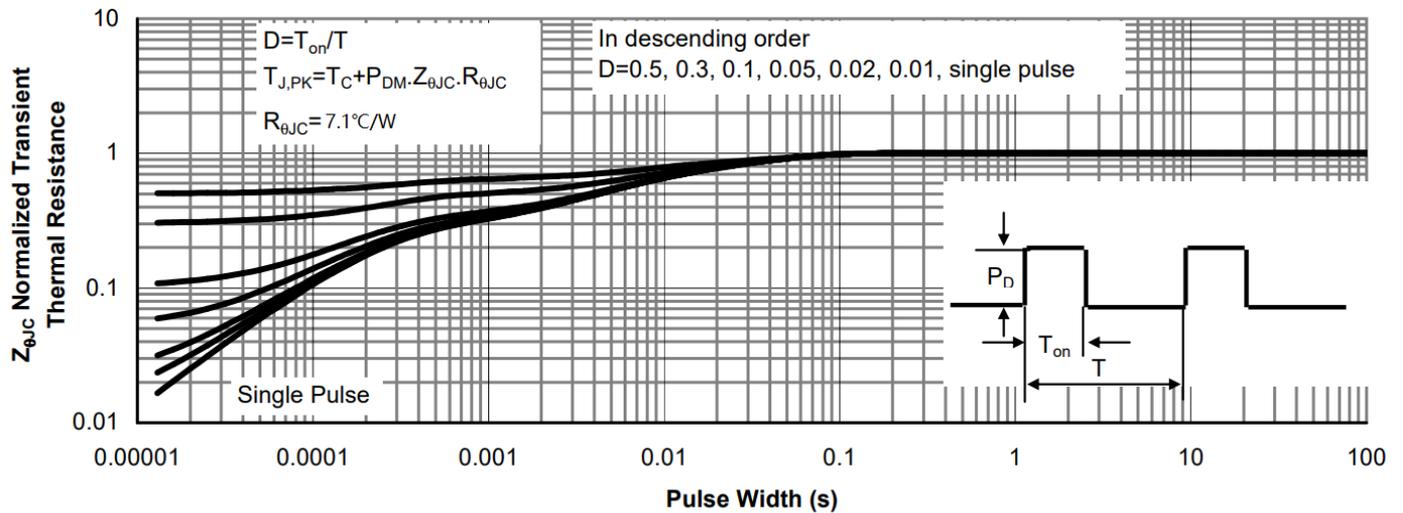
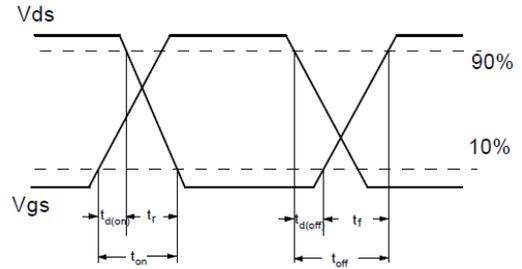
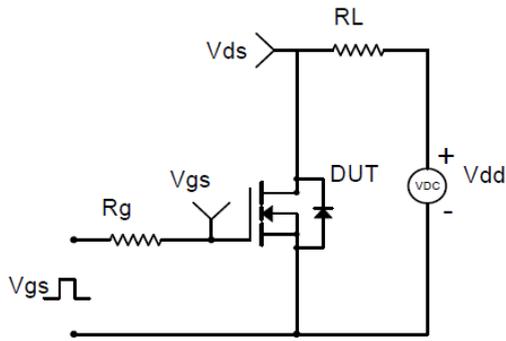
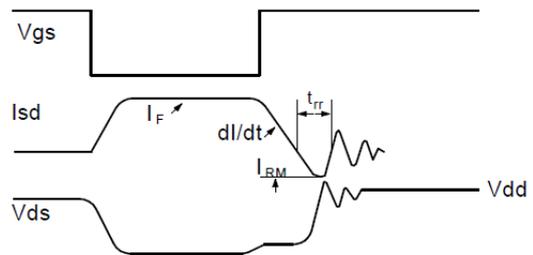
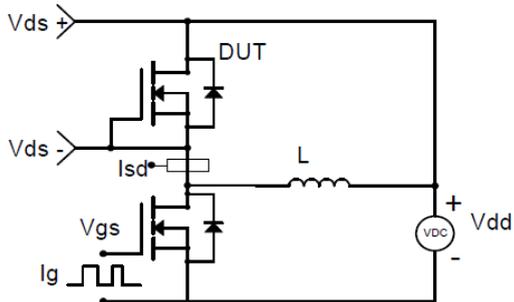


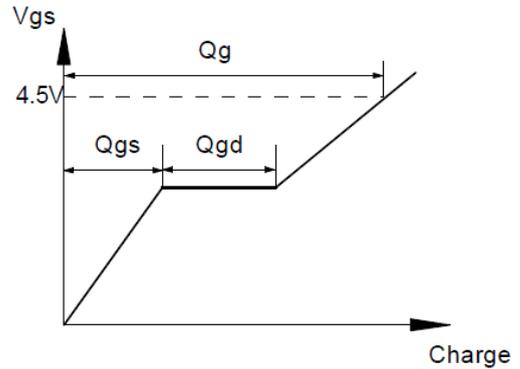
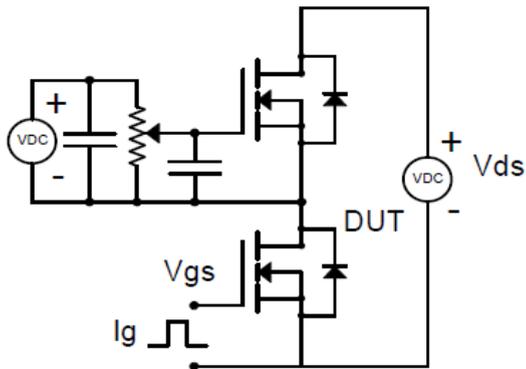
Figure9. Normalized Maximum Transient Thermal Impedance



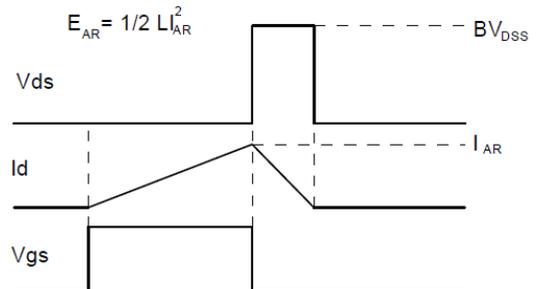
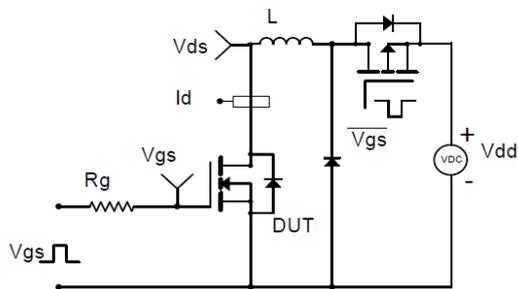
Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

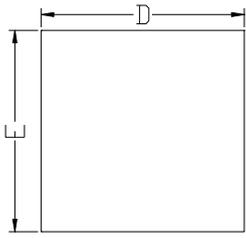


Gate Charge Test Circuit & Waveform

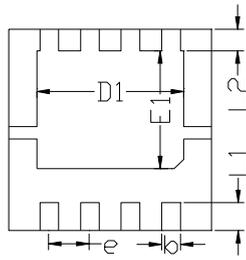


Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

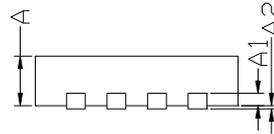
■DFN3333-8L Package information



Top View  
正面视图

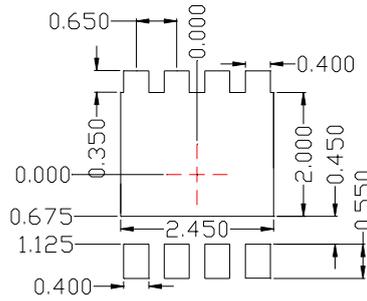


Bottom View  
背面视图



Side View  
侧面视图

| SYMBOL | MILLIMETER |      |      |
|--------|------------|------|------|
|        | MIN        | NOM  | MAX  |
| D      | 3.15       | 3.25 | 3.35 |
| E      | 3.15       | 3.25 | 3.35 |
| A      | 0.70       | 0.80 | 0.90 |
| A1     | 0.20 BSC   |      |      |
| A2     |            |      | 0.10 |
| D1     | 2.20       | 2.35 | 2.50 |
| E1     | 1.80       | 1.90 | 2.00 |
| L1     | 0.35       | 0.45 | 0.55 |
| L2     | 0.35 BSC   |      |      |
| b      | 0.20       | 0.30 | 0.40 |
| e      | 0.65 BSC   |      |      |



Suggested Solder Pad Layout  
Top View

Note:

1. Controlling dimension: in millimeters.
2. General tolerance: +/-0.10mm.
3. The pad layout is for reference purposes only.

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